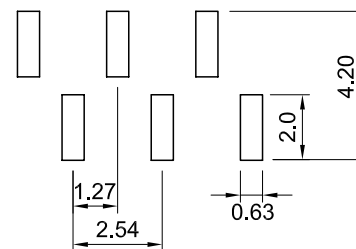
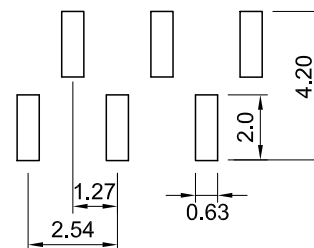


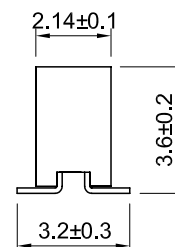
Recommended P.C. Board SMD Layout



A Type



B Type



Specifications

Current Rating: 1 Amps
Insulator Resistance: 1000 Megohms min.
Contact Resistance: 20 m ohms max.
Dielectric Withstanding: AC 300V
Operating Temperature : -55°C ~ +125°C
Contact Material: Phosphor Bronze
Insulator Material: Polyester, UL 94V-0, LCP
Contact Plated: See Option / Standard = Full Gold Flash

Part Numbering System

FH7C-SS-342132 - X XX - X X X L

Series _____
Pin Layout Type: _____
A = A Type
B = B Type
No. of Pins _____
Contact Plating _____
Cap Option: _____
Nil = No Cap
F = Film
M = Metal Cap
P = Plastic Cap
Packing Method: _____
B = Tube
T = Tape and Reel
Insulator Material: _____
L = LCP

* Contact
Plating
Option

Full Gold Plating

Gold Plated On Contact Area
Tin Plated on Solder Area

Full Tin Plating

G : Gold Flash
G10: Gold 10u"
G15: Gold 15u"
G30: Gold 30u"

S: Gold Flash
S10: Gold 10u"
S15: Gold 15u"
S30: Gold 30u"

T: Tin 100u"

General Tolerance

X. ± 0.50 X.° ± 5°

.X ± 0.20 .X° ± 2°

.XX ± 0.10 .XX° ± 1°

Units : mm